



2N7002K-AU

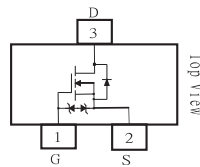
60V N-Channel Enhancement Mode MOSFET - ESD Protected

FEATURES

- $R_{DS(ON)}, V_{GS}@10V, I_{DS}@500mA=3\Omega$
- $R_{DS(ON)}, V_{GS}@4.5V, I_{DS}@200mA=4\Omega$
- Advanced Trench Process Technology
- High Density Cell Design For Ultra Low On-Resistance
- Very Low Leakage Current In Off Condition
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers : Relays, Displays, Lamps, Solenoids, Memories, etc.
- ESD Protected 2KV HBM
- Acquire quality system certificate : TS16949
- AEC-Q101 qualified
- Lead free in comply with EU RoHS 2002/95/EC directives.
- Green molding compound as per IEC61249 Std. . (Halogen Free)

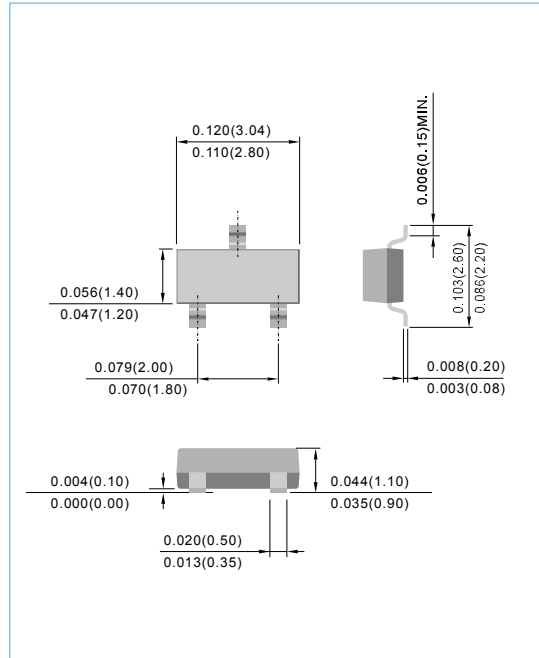
MECHANICAL DATA

- Case: SOT-23 Package
- Terminals : Solderable per MIL-STD-750,Method 2026
- Apporx. Weight: 0.0003 ounces, 0.0084 grams
- Marking : K72



SOT-23

Unit : inch(mm)



Maximum RATINGS and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	Symbol	Limit	Units
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	300	mA
Pulsed Drain Current ¹⁾	I _{DM}	2000	mA
Maximum Power Dissipation	P _D	350 210	mW
		T _A =25°C T _A =75°C	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to + 150	°C
Junction-to Ambient Thermal Resistance(PCB mounted) ²⁾	R _{θJA}	357	°C/W

- Note: 1. Maximum DC current limited by the package
2. Surface mounted on FR4 board, t < 5 sec

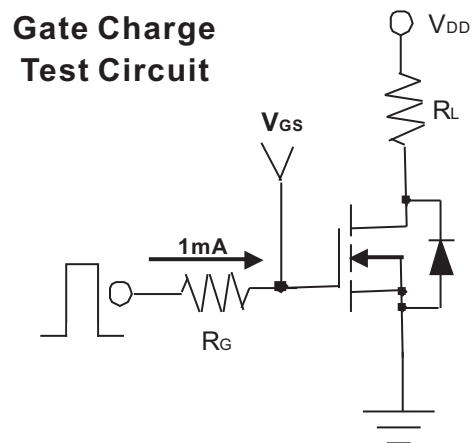
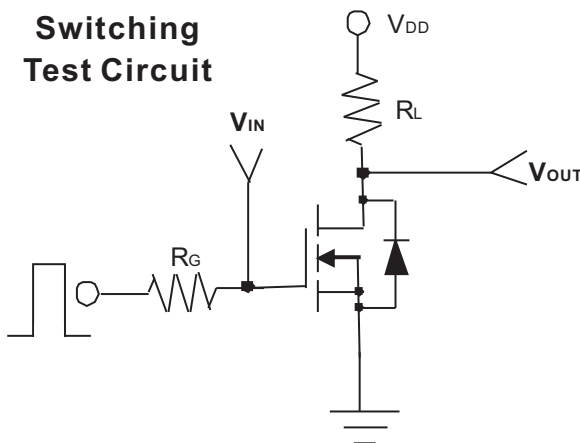
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2N7002K-AU

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Units
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=10\mu A$	60	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	2.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=200mA$	-	-	4.0	Ω
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=500mA$	-	-	3.0	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$	-	-	1	μA
Gate Body Leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±10	μA
Forward Transconductance	g_{fs}	$V_{DS}=15V, I_D=250mA$	100	-	-	mS
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=15V, I_D=200mA$ $V_{GS}=5V$	-	-	0.8	nC
Turn-On Time	t_{on}	$V_{DD}=30V, R_L=150\Omega$ $I_D=200mA, V_{GEN}=10V$ $R_G=10\Omega$	-	-	20	ns
Turn-Off Time	t_{off}		-	-	40	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$	-	-	35	pF
Output Capacitance	C_{oss}		-	-	10	
Reverse Transfer Capacitance	C_{rss}		-	-	5	
Source-Drain Diode						
Diode Forward Voltage	V_{SD}	$I_S=200mA, V_{GS}=0V$	-	0.82	1.3	V
Continuous Diode Forward Current	I_S	-	-	-	300	mA
Pulse Diode Forward Current	I_{SM}	-	-	-	2000	mA





2N7002K-AU

Typical Characteristics Curves ($T_A=25^\circ\text{C}$, unless otherwise noted)

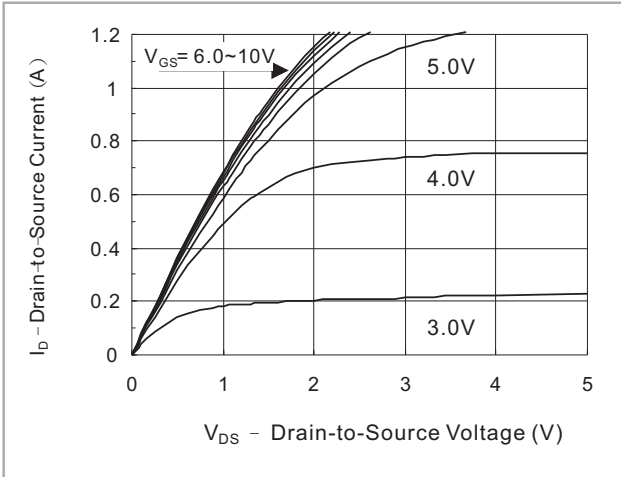


FIG.1- Output Characteristic

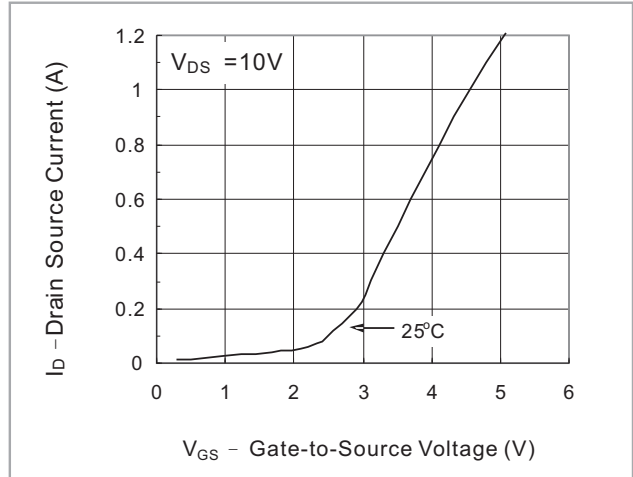


FIG.2- Transfer Characteristic

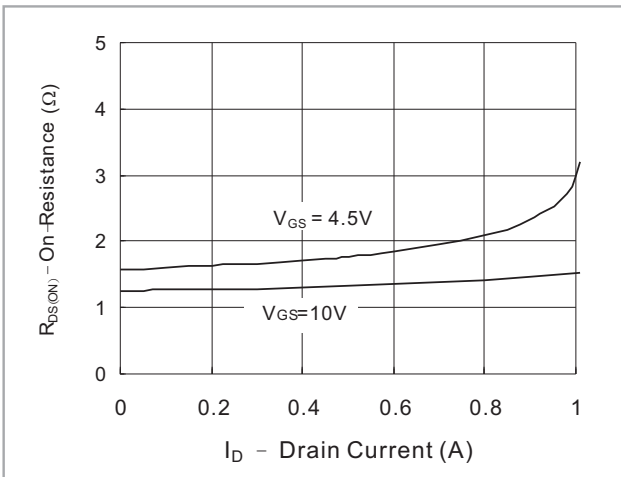


FIG.3- On Resistance vs Drain Current

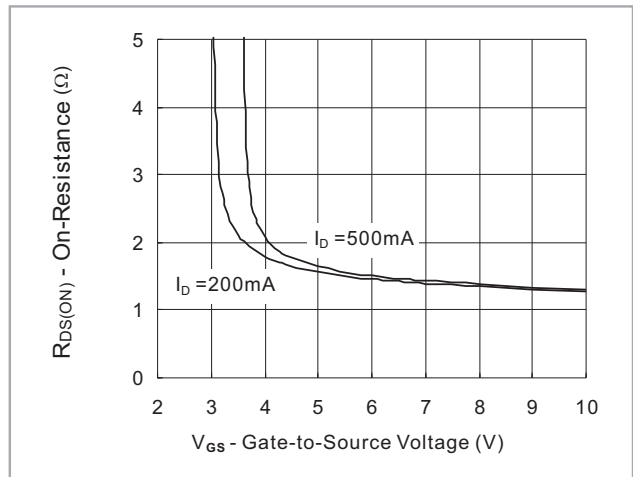


FIG.4- On Resistance vs Gate to Source Voltage

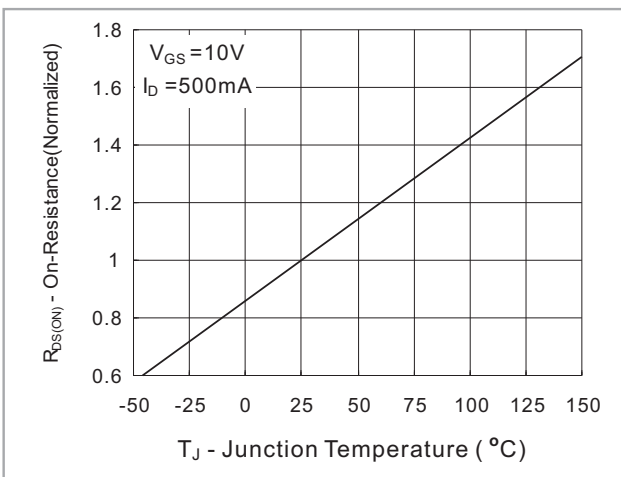


FIG.5- On Resistance vs Junction Temperature



2N7002K-AU

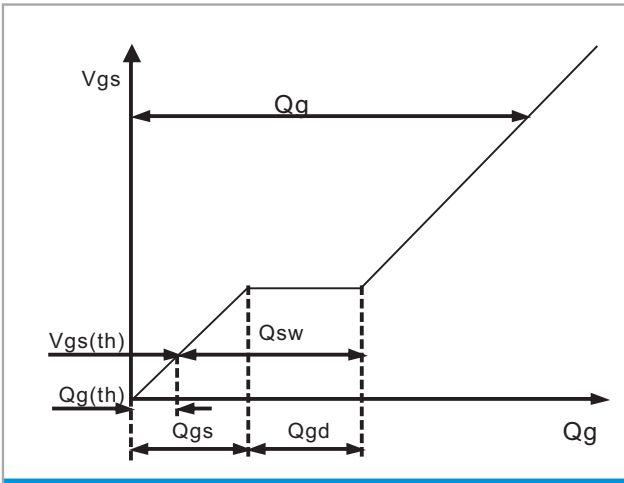


Fig. 6 - Gate Charge Waveform

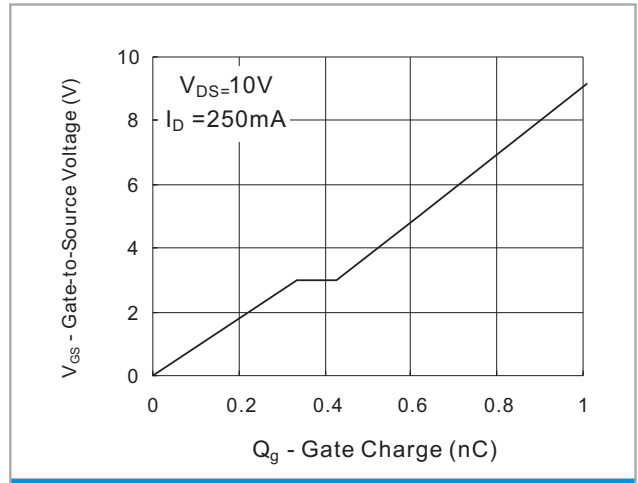


Fig. 7 - Gate Charge

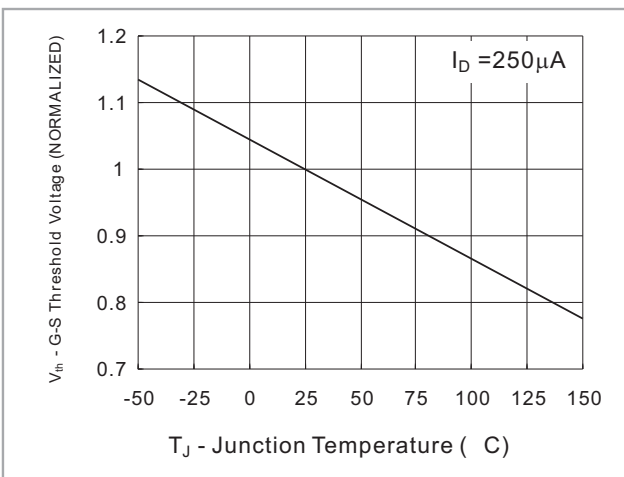


Fig. 8 - Threshold Voltage vs Temperature

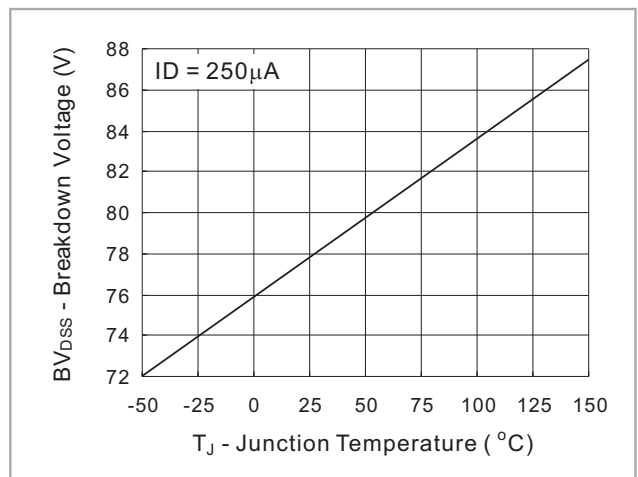


Fig. 9 - Breakdown Voltage vs Junction Temperature

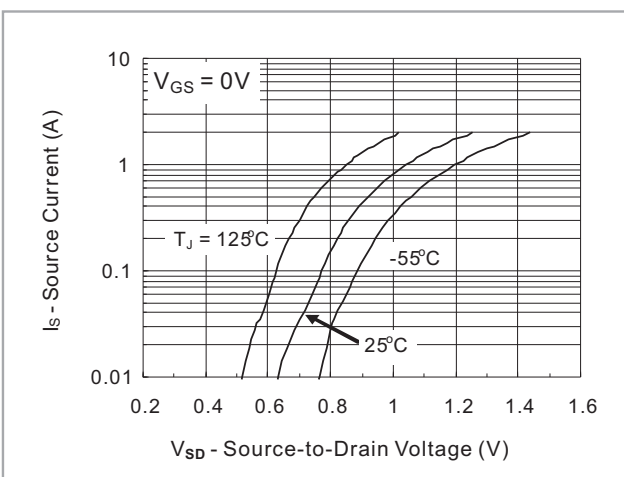


Fig. 10 - Source-Drain Diode Forward Voltage

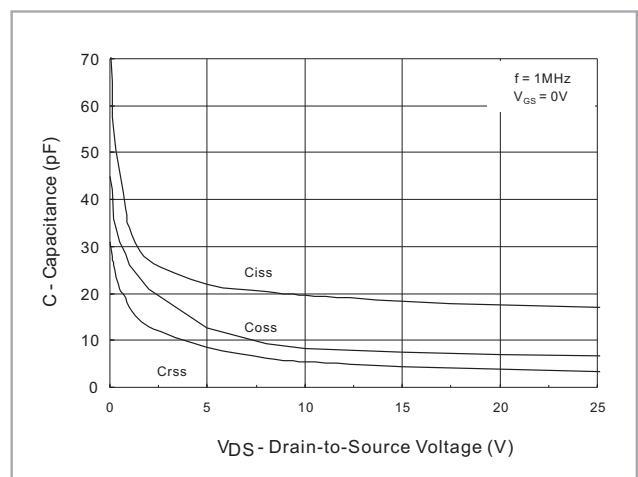
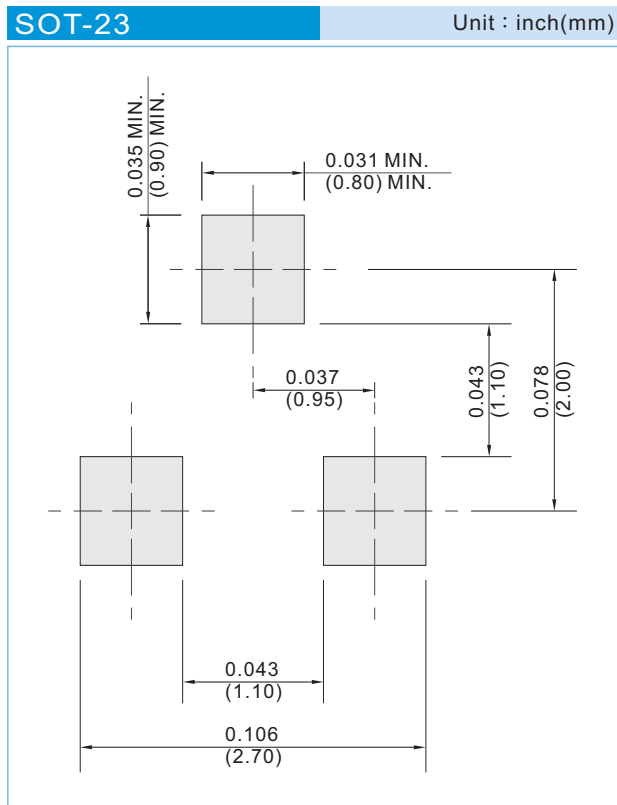


Fig. 11 - Capacitance vs Drain to Source Voltage



2N7002K-AU

MOUNTING PAD LAYOUT



ORDER INFORMATION

- Packing information
T/R - 12K per 13" plastic Reel
T/R - 3K per 7" plastic Reel



2N7002K-AU

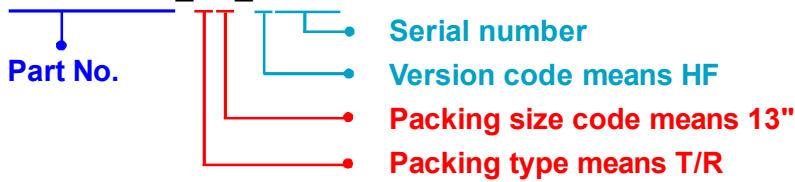
Part No_packing code_Version

2N7002K-AU_R1_000A1

2N7002K-AU_R2_000A1

For example :

RB500V-40_R2_00001



Packing Code XX				Version Code XXXXX		
Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code
Tape and Ammunition Box (T/B)	A	N/A	0	HF	0	serial number
Tape and Reel (T/R)	R	7"	1	RoHS	1	serial number
Bulk Packing (B/P)	B	13"	2			
Tube Packing (T/P)	T	26mm	X			
Tape and Reel (Right Oriented) (TRR)	S	52mm	Y			
Tape and Reel (Left Oriented) (TRL)	L	PANASERT T/B CATHODE UP (PBCU)	U			
FORMING	F	PANASERT T/B CATHODE DOWN (PBCD)	D			



2N7002K-AU

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